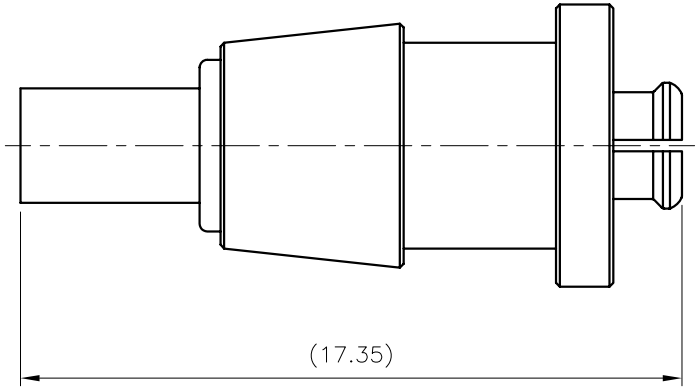
REVISION

REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2016.04.22.
1	Cap 형상 변경 Rev	I.C.KIM		2016.07.28.
2	조립 후 전장 치수 수정 부품 구성 변경	I.C.KIM		2017.02.16.



	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
	10	SPRING	1	SUS303	Gold Plate	DSR01120-5/2
	9	SPRING	1	SUS303	Passivate	DSR01150-5/1
	8	RING	1	BeCu C17300	Gold Plate	DSR01149-5/2
1	7	CAP	1	MBsBD C3604BD-F	Nickel Plate	DCU02279-5/3
	6	INSULATOR	1	TEFLON		DIN02754-N/1
	5	INSULATOR	1	TEFLON		DIN02755-N/1
	4	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03682-5/1
	3	CONTACT	1	BeCu C17300	Gold Plate	DCT03683-5/1
2	2	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04153-5/2
2	1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04154-5/2

TOLERANCE	Decimal ±0.15	DATE	2017. 02. 16.
	Angle ±1°	APPROVED BY	
MATERIAL		CHECKED BY	
		DRAWN BY	I.C.KIM
FINISH		SCALE 5/1	UNIT mm

KJ COMTECH
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TITLE GIGALANE(1.2t) (J) KSMP50 trans (J) ADAPTOR

A4 | DWG NO. AD00579-7/3 | REVISION 2 | SHEET 1 of 1